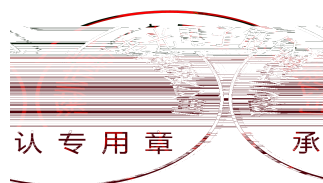
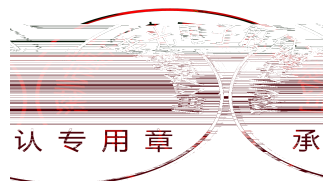


SPECIFICATION

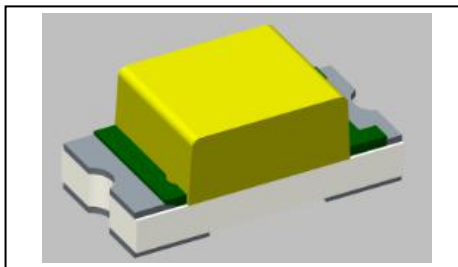


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1. Description

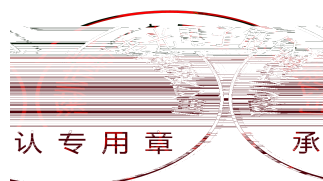
1.1 General Description



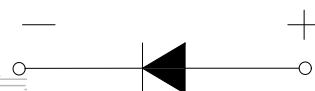
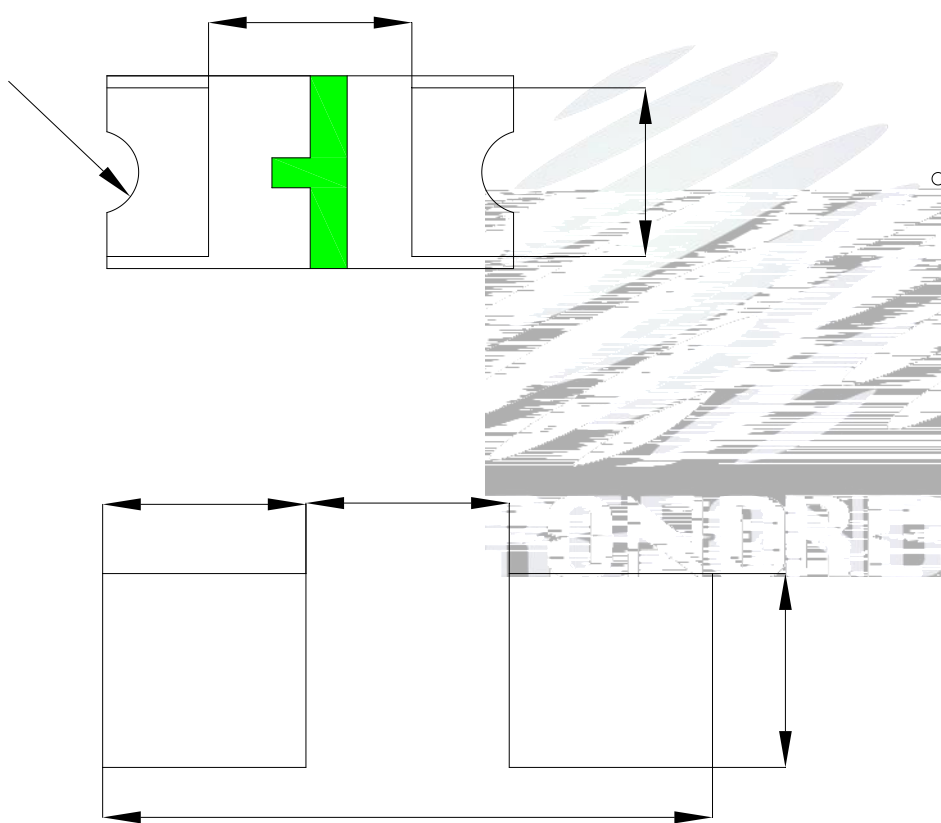
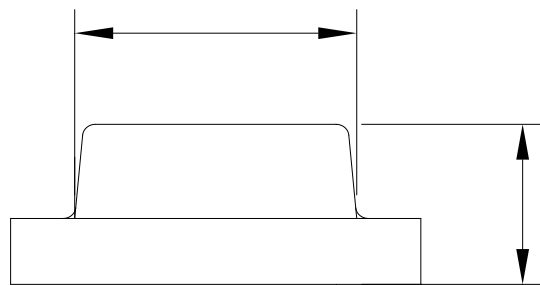
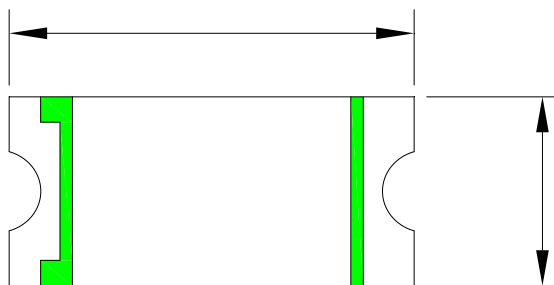
1.2 Features



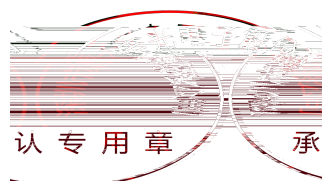
1.3 Application

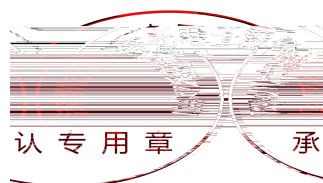


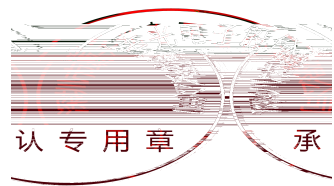
1.4 Package Dimension



±

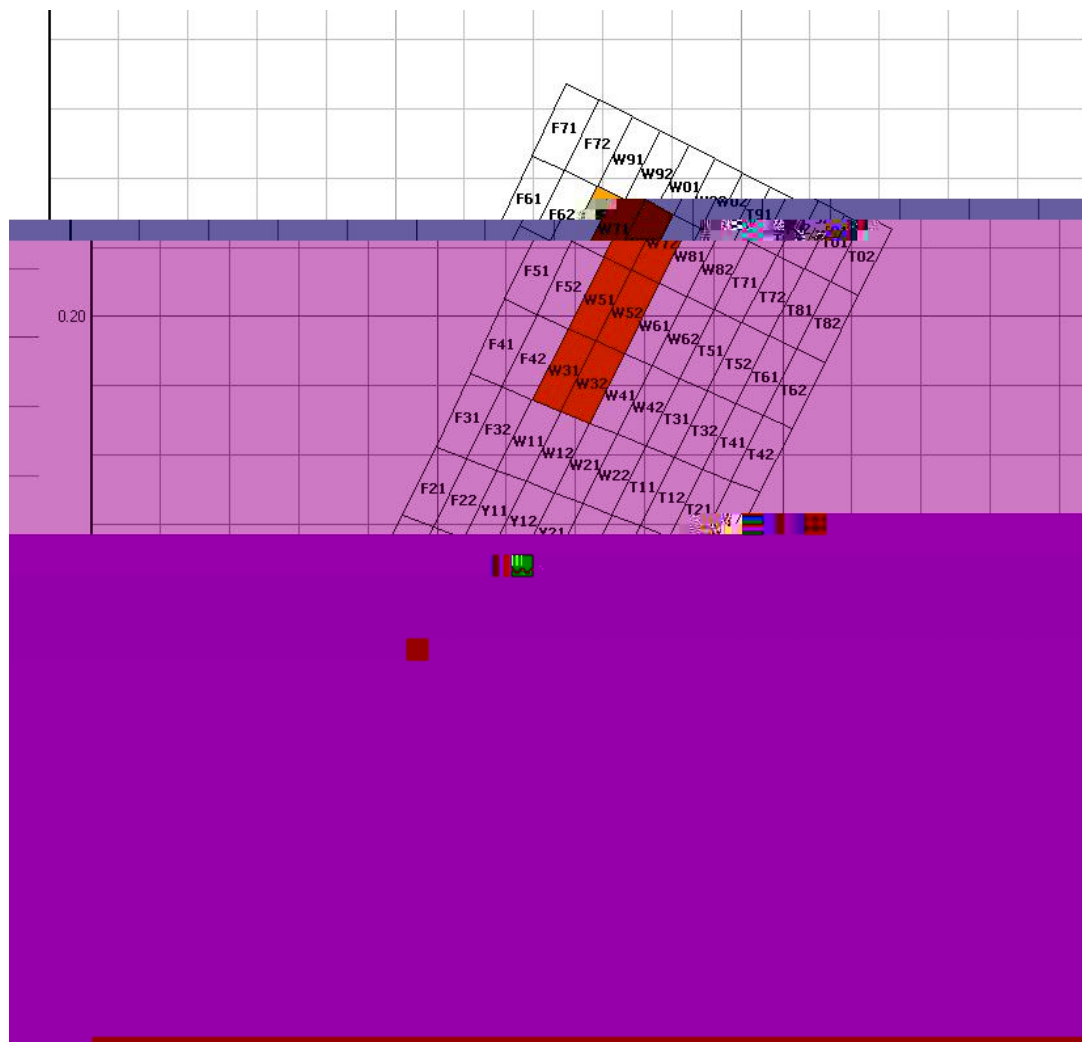


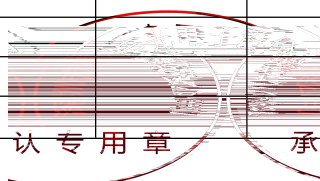
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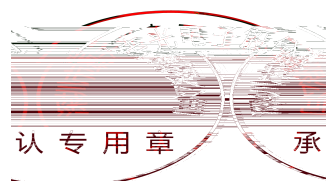


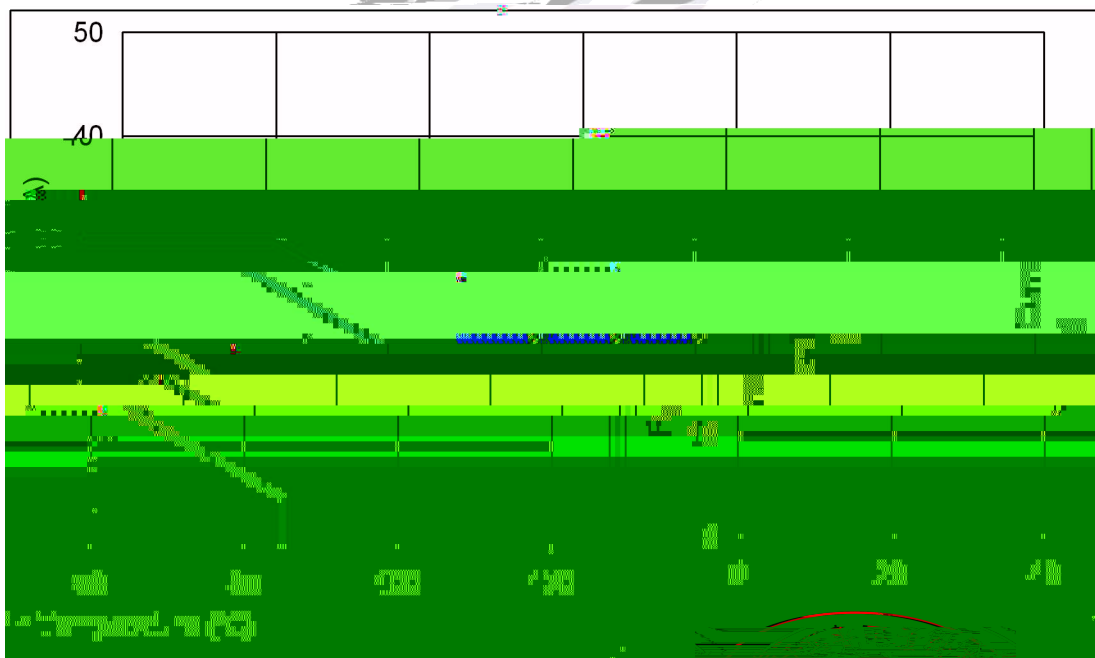
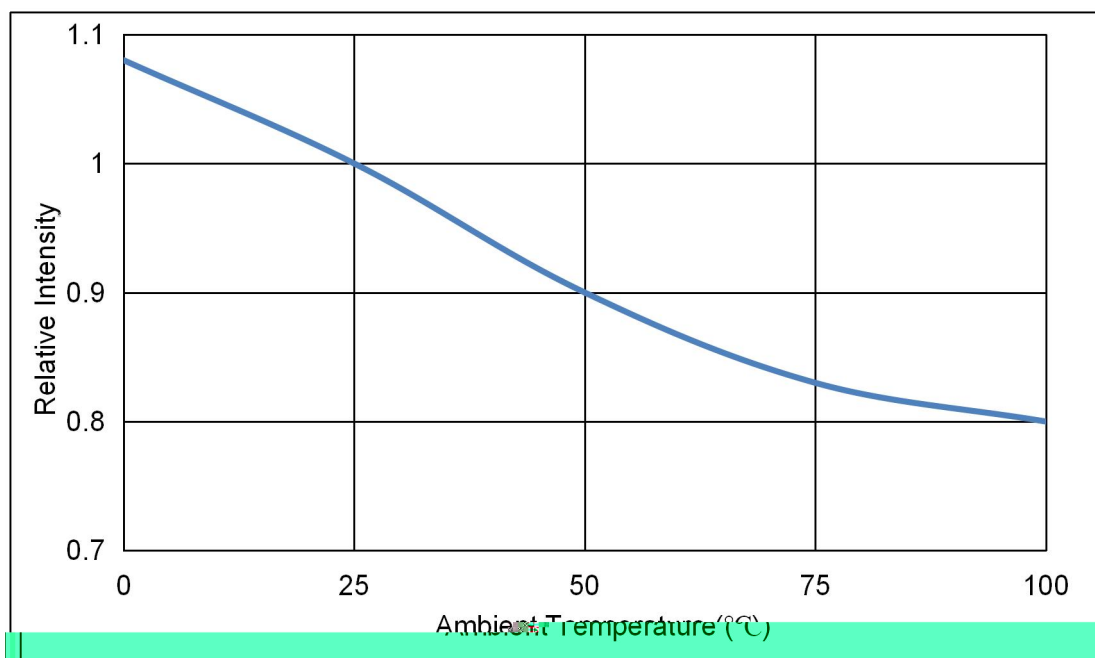
1.6 Bin Range Of Forward Voltage and Luminous Flux (IF=20mA)

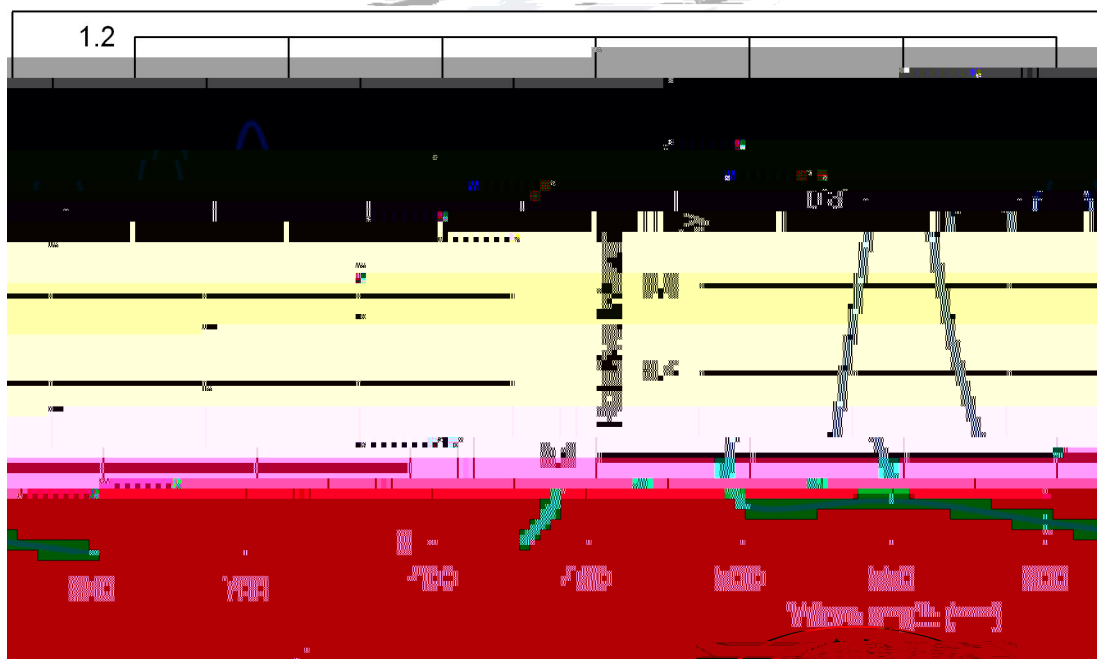
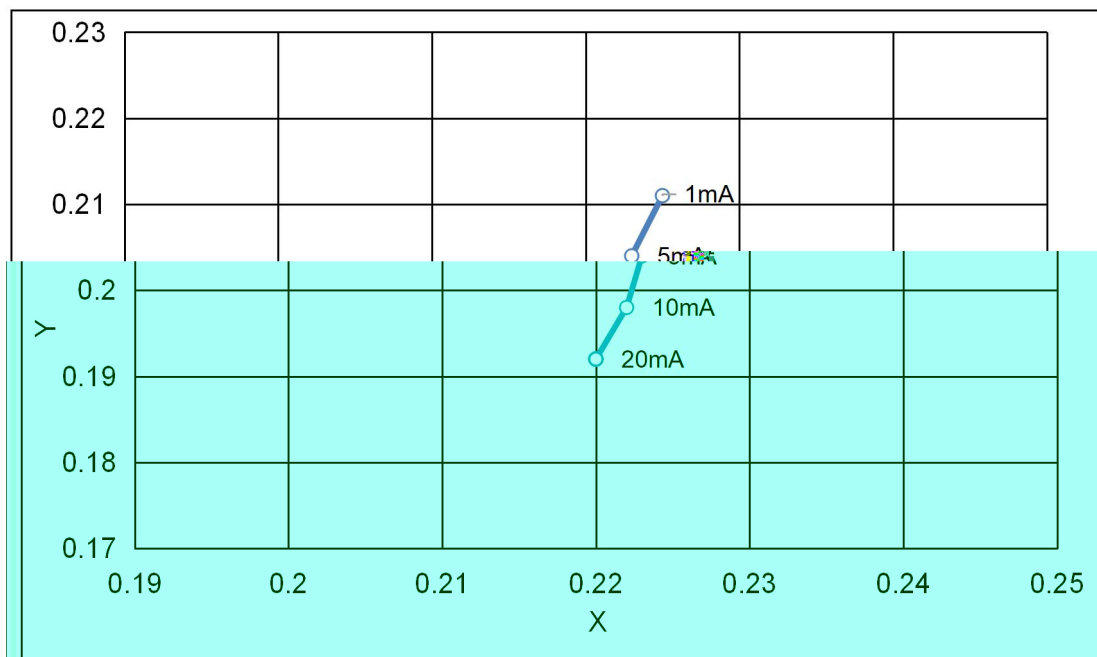
BIN (IF=20mA)

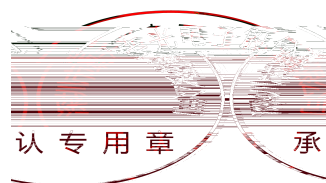
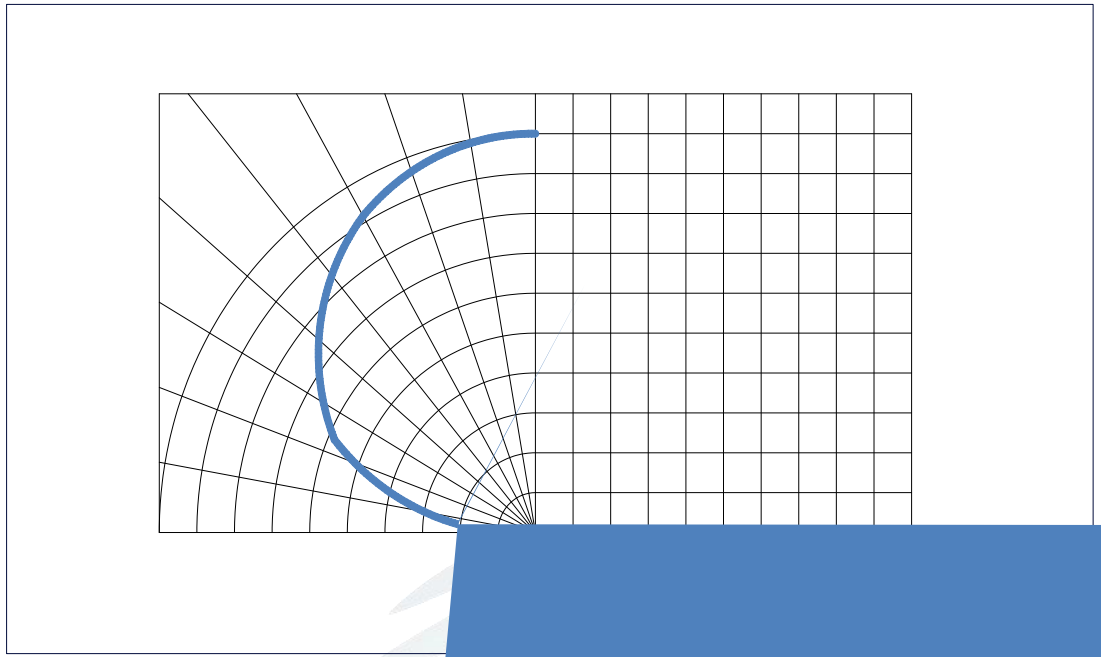






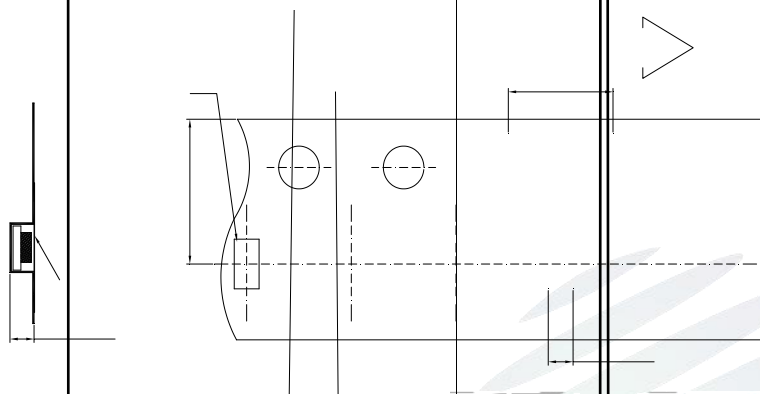


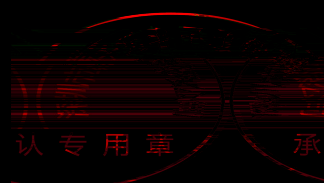




2. Packaging

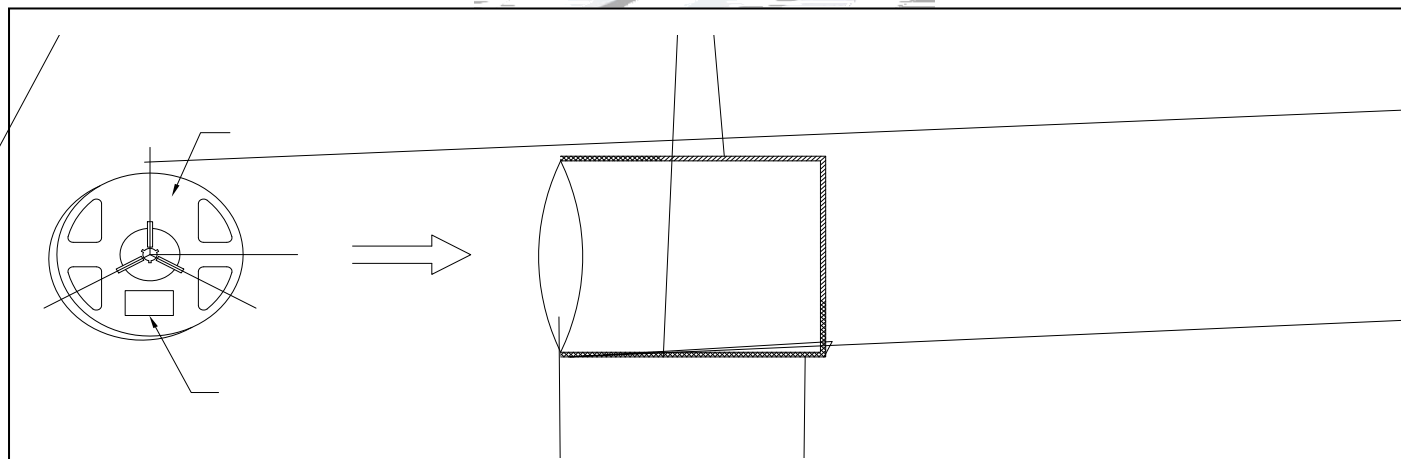
2.1 Packaging Specification



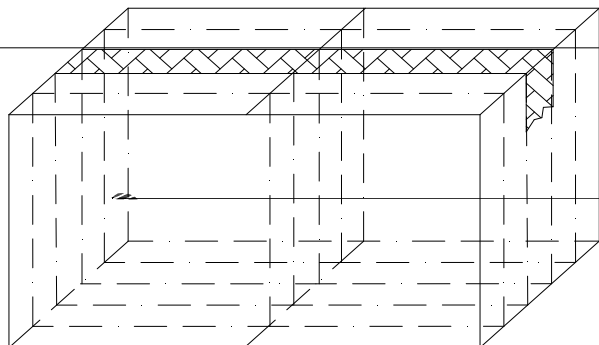
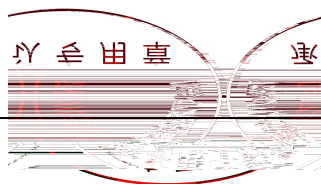




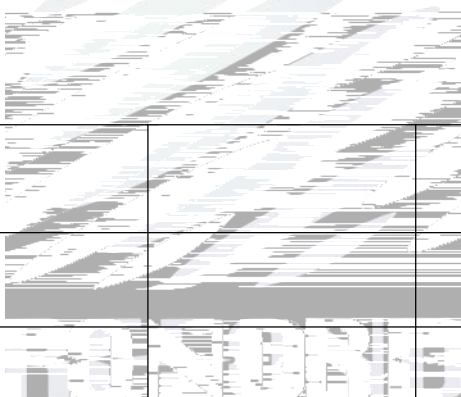
2.2 Moisture Resistant Packing



2.3 Cardboard Box



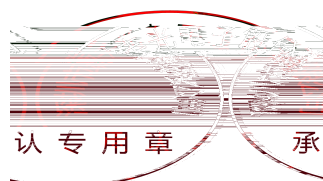
2.4 Reliability Test Items And Conditions



3. SMT Reflow Soldering Instructions SMT

3.1 SMT Reflow Soldering Instructions SMT

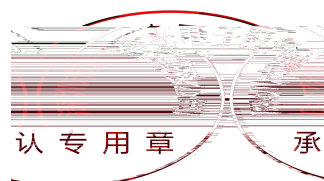




4. Handling Precautions

4.1 Handling Precautions







[illegible]

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